Docket No.: K-0

K-009

## DECLARATION AND POWER OF ATTORNEY

are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled METHOD AND SYSTEM FOR PROVIDING INTER-FREQUENCY HANDOFF IN A TELEPHONE SYSTEM, the specification of which  [X] is attached hereto  [ ] was filed on as Application Serial No and was amended on (if applicable)  I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is known to me to be material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).  Thereby claim foreign priority or provisional application benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate, or provisional application(s) listed below and have also identified below any foreign application for patent or inventor's certificate, or provisional application(s) having a filing date before that of the application on which are inventor	As a below named inventor	r, I hereby declare tl	nat:		
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hereby claim foreign priority or provisional application benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate, or provisional application(s) listed below and have also identified below any foreign application for patent or inventor's certificate, or provisional application(s) having a filing date before that of the application on which application for patent or inventor's certificate, or provisional application(s) having a filing date before that of the application on which application for patent or inventor's certificate, or provisional application(s) having a filing date before that of the application on which application for patent or inventor's certificate, or provisional application(s):  Priority Claimed  Yes No  S5539/1997 Korea 6 November 1997 X  Thereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:  Prior U. S. Application(s):  Serial No. Filing Date Status: Patented, Pending, Abandoned	•	eviewed and underst			cation, including the claims, as amended
application(s) for patent or inventor's certificate, or provisional application(s) listed below and have also identified below any foreign application for patent or inventor's certificate, or provisional application(s) having a filing date before that of the application on which ariority is claimed:  Prior Foreign Application(s) or U.S. Provisional Application(s):  Priority Claimed  Number  Country  Day/Month/Year  Yes  No  S5339/1997  Korea  6 November 1997  X  Thereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filling date of this application:  Prior U. S. Application(s):  Serial No.  Filing Date  Status: Patented, Pending, Abandoned			which is known to me to be m	aterial to patenta	bility in accordance with Title 37, Code
Number Country Day/Month/Year. Yes No  58539/1997 Korea 6 November 1997 X  Thereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:  Prior U. S. Application(s):  Serial No. Filing Date Status: Patented, Pending, Abandoned	application(s) for patent or application for patent or in	inventor's certificat	e, or provisional application(s	) listed below an	nd have also identified below any foreign
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Serial No. Filing Date Status: Patented, Pending, Abandoned	as the subject matter of each by the first paragraph of Ti in Title 37, Code of Federa	n of the claims of this itle 35, United State l Regulations, Sectio	s application is not disclosed in s Code, Section 112, I acknow n 1.56(a) which occurred betwe	the prior United ledge the duty to	States application in the manner provided disclose material information as defined
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief			ng Date	Status: Patent	ed, Pending, Abandoned
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief					
Titleren) decime discontinue independent of the party of	I hereby declare that all sta	tements made hereir	n of my own knowledge are tr	ie and that all sta	atements made on information and belief

are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false

statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner. Registration No. 34,596; Mark G. Toohey, Registration No. 35,392; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, and Rene A. Vazquez, Registration No. 38,647, all of

The Law Offices of FLESHNER & KIM P. O. Box 221200 Chantilly, Virginia 20153-1200

with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

Full name of sole or first inv		***************************************	
Inventor's signature:	Jong Youn KIM	Date: Jan. 3	10, 1998
Residence: Kyungki-do, Koi	rea		
Citizenship: Republic of Ko	rea		
		aji-eup. Yongin-si, Kyungki-do, Korea	
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Full name of joint inventor	(s):	•	
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Residence:			
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Full name of joint inventor	(s):		
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